IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Solar Inverters
- Uninterruptable Power Supply (UPS)

ABSOLUTE MAXIMUM RATINGS

Symbol V _{CES} I _C	Value 600	Unit V
	600	V
Ι _C		
	60 30	A
I _{CM}	120	A
IF	60 30	A
I _{FM}	120	A
t _{SC}	5	μs
V _{GE}	±20 ±30	V
P _D	250 67	W
TJ	–55 to +150	°C
T _{stg}	–55 to +150	°C
T _{SLD}	260	°C
	I _F I _{FM} t _{SC} V _{GE} P _D T _J	$\begin{array}{c c c c c c c }\hline & & & & & & & & & & & & & & & & & & &$

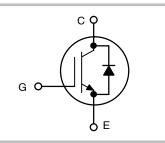
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

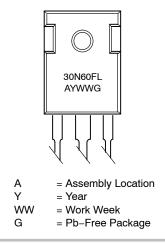
http://onsemi.com

30 A, 600 V V_{CEsat} = 1.65 V





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB30N60FLWG	TO–247 (Pb–Free)	30 Units / Rail

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THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.486	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.06	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

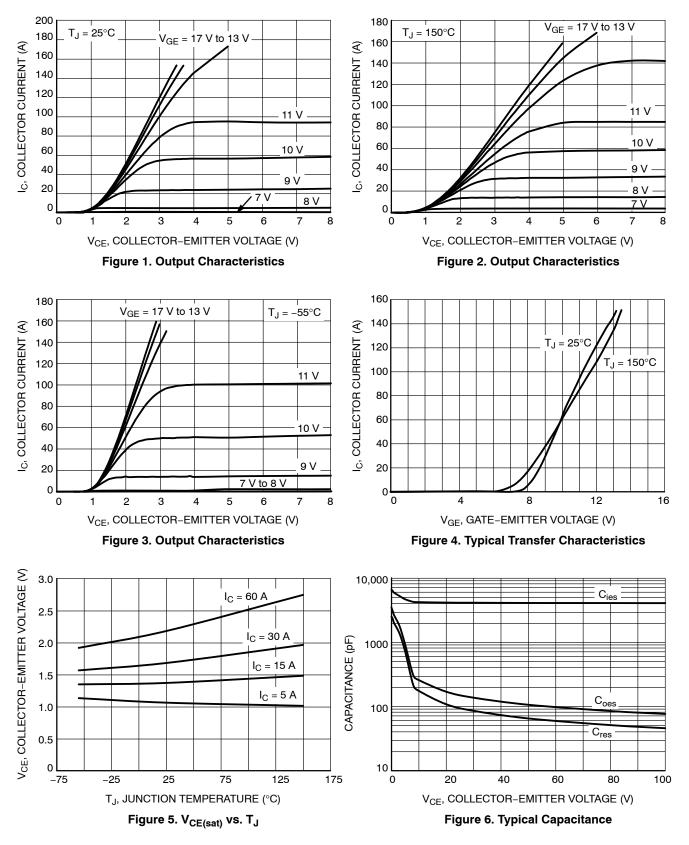
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	·			•	•	-
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	600	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 30 A V_{GE} = 15 V, I _C = 30 A, T _J = 150°C	V _{CEsat}	1.4 _	1.65 2.0	1.9 _	V
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 200 μ A	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$\label{eq:VGE} \begin{array}{l} V_{GE} = 0 \ V \!, V_{CE} = 600 \ V \\ V_{GE} = 0 \ V \!, V_{CE} = 600 \ V \!, T_{J} = 150^{\circ} C \end{array}$	I _{CES}	-		0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	4200	_	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	_	170	_	
Reverse transfer capacitance		C _{res}	_	110	-	
Gate charge total		Qg	_	170	-	nC
Gate to emitter charge	V_{CE} = 480 V, I _C = 30 A, V _{GE} = 15 V	Q _{ge}	-	34	-	
Gate to collector charge		Q _{gc}	-	83	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	_	83	-	ns
Rise time		tr	-	31	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	_	170	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	80	-	
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	-	0.7	-	mJ
Turn-off switching loss	1	E _{off}	-	0.28	-	
Total switching loss		E _{ts}	-	0.98	-	
Turn-on delay time		t _{d(on)}	-	81	-	ns
Rise time		tr	-	32	-	
Turn-off delay time	$T_J = 150^{\circ}C$ $V_{CC} = 400 \text{ V, } I_C = 30 \text{ A}$ $R_g = 10 \Omega$	t _{d(off)}	-	180	-	
Fall time		t _f	-	110	-	
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	-	0.82	-	mJ
Turn-off switching loss]	E _{off}	-	0.63	I	
Total switching loss	7	E _{ts}	_	1.45	-	

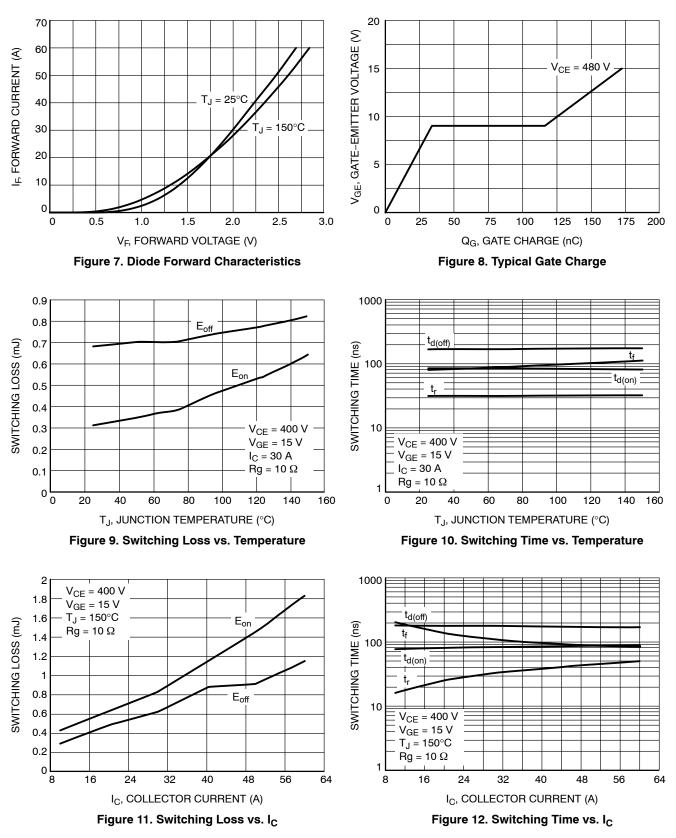
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 30 A V_{GE} = 0 V, I _F = 30 A, T _J = 150°C	V _F	1.45 -	1.9 2.0	2.35 -	V
Reverse recovery time	T.I = 25°C	t _{rr}	-	72	-	ns
Reverse recovery charge	I _F = 30 Å, V _R = 200 V	Q _{rr}	-	0.25	-	μC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	-	6	-	А

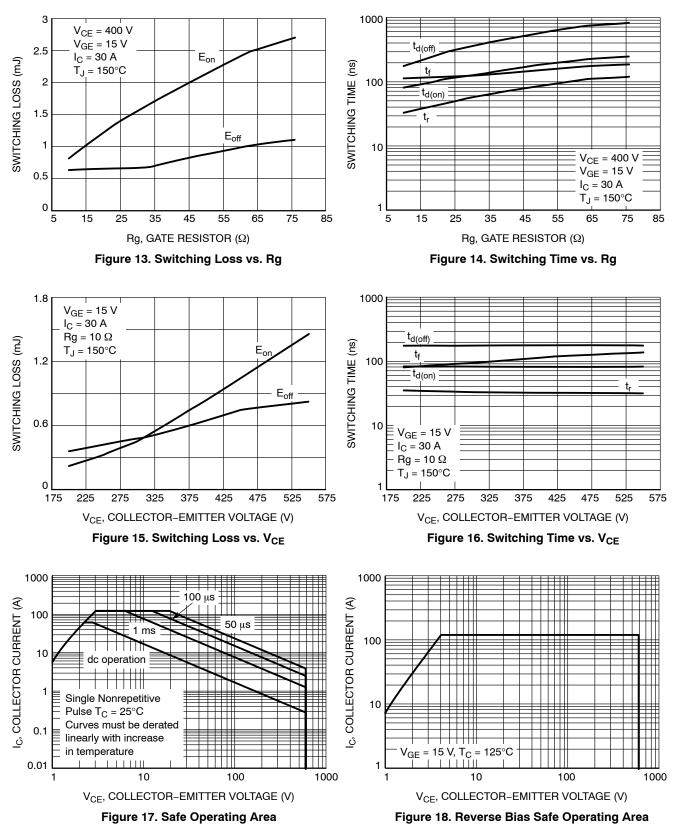
TYPICAL CHARACTERISTICS



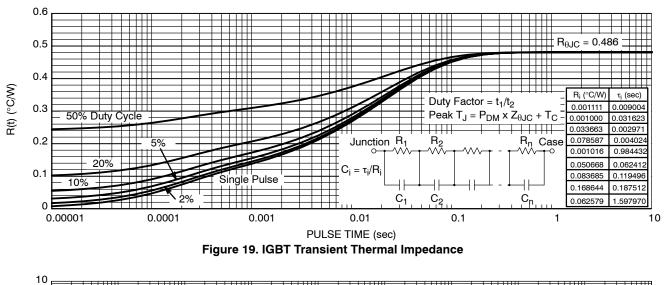
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS







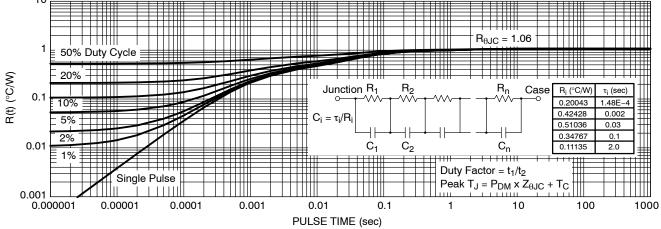


Figure 20. Diode Transient Thermal Impedance

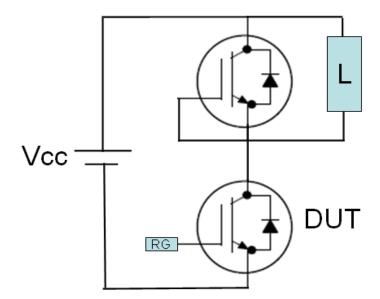


Figure 21. Test Circuit for Switching Characteristics

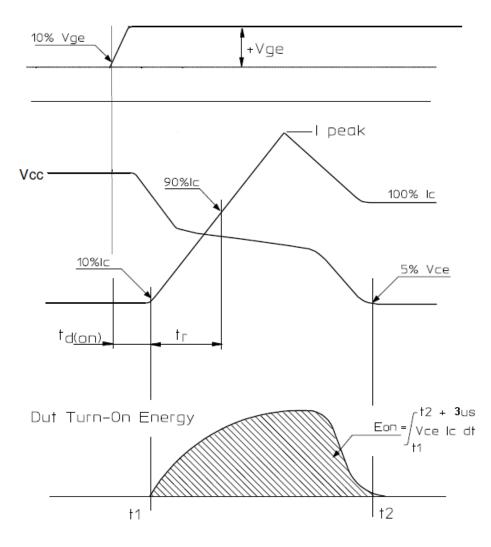


Figure 22. Definition of Turn On Waveform

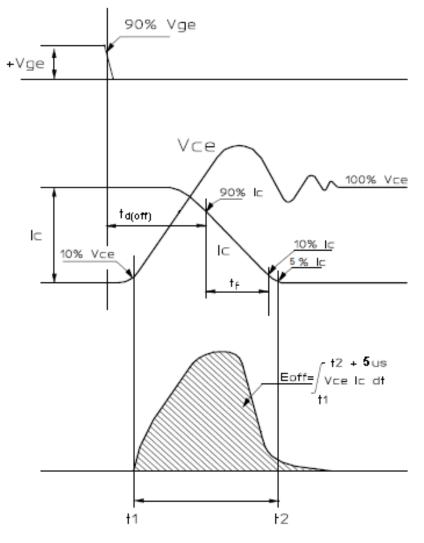


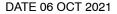
Figure 23. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

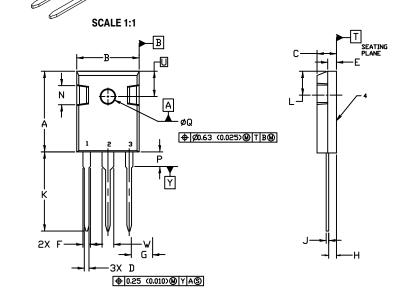


TO-247 CASE 340L ISSUE G



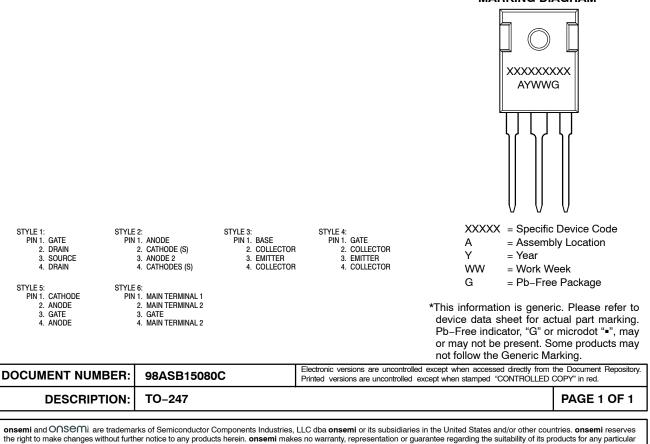


- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER



	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Е	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	6.15 BSC		BSC
W	2.87	3.12	0.113	0.123

GENERIC **MARKING DIAGRAM***



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